



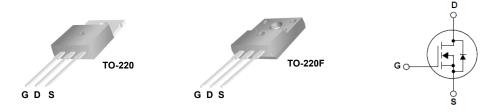
# SLP5N50S / SLF5N50S **500V N-Channel MOSFET**

### **General Description**

This Power MOSFET is produced using Maple semi's advanced planar stripe DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction based on half bridge topology.

#### **Features**

- 5A, 500V, R<sub>DS(on) typ.</sub> = 1.12 $\Omega$ @V<sub>GS</sub> = 10 V Low gate charge ( typical 22 nC)
- High ruggedness
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



### **Absolute Maximum Ratings**

T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		SLP5N50S	SLF5N50S	Units
V <sub>DSS</sub>	Drain-Source Voltage		500		V
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°C)		5.0		А
	- Continuous (T <sub>C</sub> = 100°C)		3.2		А
T <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	18		А
$V_{GSS}$	Gate-Source Voltage		±30		V
EAS	Single Pulsed Avalanche Energy	(Note 2)	300		mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	5.0		А
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	6.5		mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5		V/ns
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> = 25°C)		73	38	W
	- Derate above 25°C		0.58	0.30	W/°C
$T_J,T_STG$	Operating and Storage Temperature Range		-55 to +150		℃
T <sub>L</sub>	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300		°C

<sup>\*</sup> Drain current limited by maximum junction temperature.

#### Thermal Characteristics

Symbol	Parameter	SLP5N50S	SLF5N50S	Units
R <sub>e.IC</sub>	Thermal Resistance, Junction-to-Case	1.71	3.29	°C/W
R <sub>e,JS</sub>	Thermal Resistance, Case-to-Sink Typ.	-	-	°C/W
R <sub>e,JA</sub>	Thermal Resistance, Junction-to-Ambient	62.5	62.5	°C/W

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Ch	aracteristics				•	•
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250 \text{ uA}$	500			V
∆BV <sub>DSS</sub> / △T <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 uA, Referenced to 25°C		0.5		V/°C
	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V			25	uA
I <sub>DSS</sub>		V <sub>DS</sub> = 400 V, T <sub>C</sub> = 125℃			250	uA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -30 V, V <sub>DS</sub> = 0 V			-100	nA
On Cha	aracteristics				•	•
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \text{ uA}$	2.0		4.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 2.5 A		1.12	1.5	Ω
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 2.5 A (Note 4)		4.2		S
Dynam	ic Characteristics				<u> </u>	· I
C <sub>iss</sub>	Input Capacitance			600		pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		100		pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1.0 WH12		20		pF
Switch	ing Characteristics					1
t <sub>d(on)</sub>	Turn-On Delay Time			10		ns
t <sub>r</sub>	Turn-On Rise Time	$V_{DD} = 250 \text{ V}, I_D = 5\text{A},$		15		ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$R_G = 25 \Omega$ (Note 4, 5)		33		ns
t <sub>f</sub>	Turn-Off Fall Time	- (14016 4, 3)		16		ns
Q <sub>a</sub>	Total Gate Charge	V <sub>DS</sub> = 400 V, I <sub>D</sub> = 5A,		22		nC
Q <sub>as</sub>	Gate-Source Charge	V <sub>GS</sub> = 10 V		3.5		nC
Q <sub>gd</sub>	Gate-Drain Charge	(Note 4, 5)		11		nC
Drain-S	Source Diode Characteristics a	nd Maximum Ratings				
I <sub>s</sub>	Maximum Continuous Drain-Source Diode Forward Current				5	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current				18	Α
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 5A			1.6	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0 \text{ V, } I_{S} = 5\text{A,}$		350		ns

#### Notes:

- Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature 2.  $I_{AS}$  =5A,L=24mH,  $V_{DD}$  = 50V,  $R_{G}$  = 25 $\Omega$ , Starting  $T_{J}$  = 25°C 3.  $I_{SD}$  ≤ 5A, di/dt ≤ 200A/us,  $V_{DD}$  ≤ BV<sub>DSS</sub>, Starting  $T_{J}$  = 25°C 4. Pulse Test: Pulse width ≤ 300us, Duty cycle ≤ 2%

- 5. Essentially independent of operating temperature

## **Typical Characteristics**

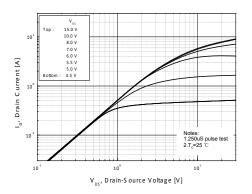


Figure 1. On-Region Characteristics

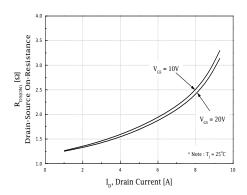
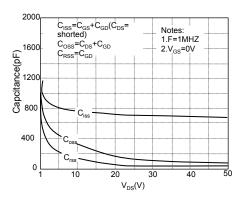


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage



**Figure 5. Capacitance Characteristics** 

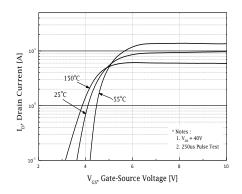


Figure 2. Transfer Characteristics

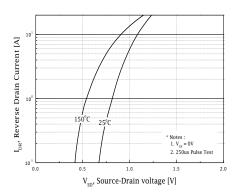
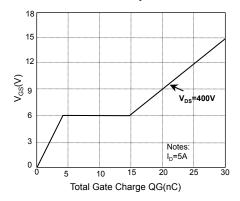


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature



**Figure 6. Gate Charge Characteristics** 

### Typical Characteristics (Continued)

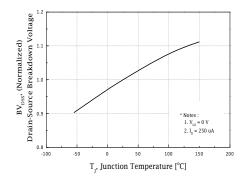


Figure 7. Breakdown Voltage Variation vs Temperature

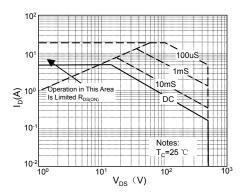


Figure 9-1. Maximum Safe Operating Area (SLP5N50S)

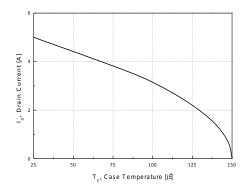


Figure 10. Maximum Drain Current vs Case Temperature

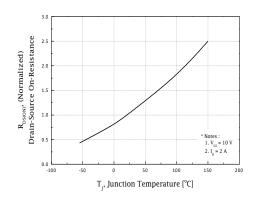


Figure 8. On-Resistance Variation vs Temperature

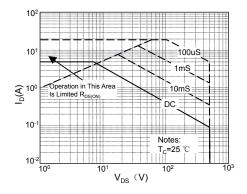


Figure 9-2. Maximum Safe Operating Area (SLF5N50S)

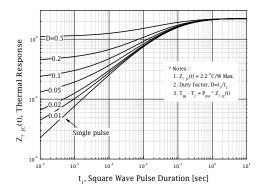
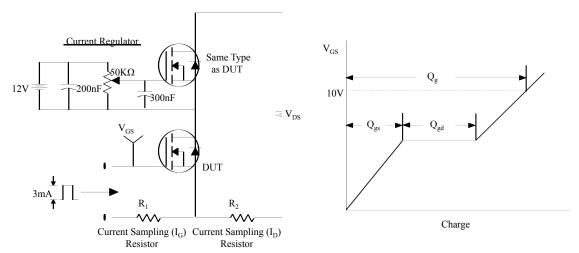
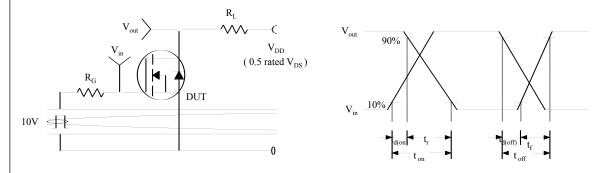


Figure 11. Transient Thermal Response Curve

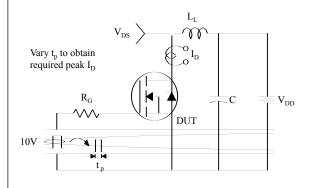
# **Gate Charge Test Circuit & Waveform**

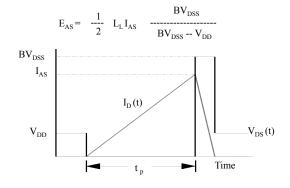


### Resistive Switching Test Circuit & Waveforms

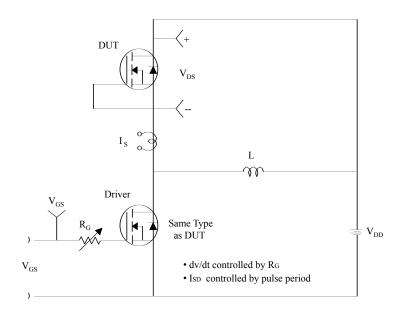


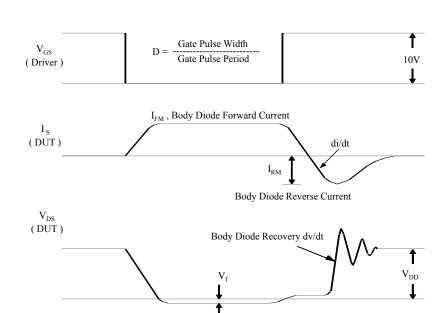
# **Unclamped Inductive Switching Test Circuit & Waveforms**





# Peak Diode Recovery dv/dt Test Circuit & Waveforms





Body Diode Forward Voltage Drop

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